



NOTES:

1.MATERIAL:

- 1.1 HOUSING:(HIGH TEMP.)THERMOPLASTIC UL94V-0 BLACK
- 1.2 CONTACT:PHOSPHOR BRONZE
- 1.3 SHELL: BRASS

2.FONISH:

2.1 CONTACT:

- 15U" MIN. GOLD PLATED ON CONTACT AREA
- 150U" MIN. TIN(MATTE) PLATING ON SOLDER TAIL AREA
- 50U" MIN. NICKEL UNDERPLATING OVERALL

2.2.SHELL:

- 80U" MIN. SEMI-BRIGHT NICKEL PLATING OVERALL

3.RECOMMENDED PCB THICKNESS:XXmm

4.APPLIED TO IR OR WAVE SOLDERING PROCESS

5.NET WEIGHT:XXgram

6.DATE CODE

10/01/30	ING				AO
DATE	DR.BY	ECN.NO.	DESCRIPTION	MARK	VER.
-TOLERANCES- UNLESS OTHERWISE SPECIFIED			CnC Tech . LLC		
				TITLE: USB 3.0 A/F SOLDER 15U"	
X.X ±0.25	X.X" ±3.00°	APPD:	PRODUCT NO: 1003-006-01200		
X.XX ±0.20	X.XX" ±1.00°	CHECK:	DATE	SCALE	UNIT
X.XXX ±0.15	X.XXX" ±0.500°	DRAW:	2010.06.17	1:1	mm
				Z	1 / 1